MINED BY:		FILE NO . CAS-0006530
Bob Hu	EMERGING DISPLAY	ISSUE : FEB.23, 2009
ROVED BY:	TECHNOLOGIES CORPORATION	TOTAL PAGE: 32
David Chang		VERSION: 5
CUSTOMER	ACCEPTANCE SPEC	CIFICATIONS
MO FOR CUSTOMER'S APPROV	DEL NO.: ET028002DHU (RoHS) MESSRS:	
DATE:		
BY:		

MODEL NO. VERSION **PAGE** EMERGING DISPLAY TECHNOLOGIES CORPORATION ET028002DHU 5 0 - 1DOC . FIRST ISSUE NOV.13, 2007 RECORDS OF REVISION **REVISED** DATE **PAGE** SUMMARY NO. 2. MECHANICAL SPECIFICATIONS NOV.26, 2007 (1)DISPLAY SIZE (inch): $2.8" \rightarrow DIAGONALS$: 2.8 inch ADD (10) INTERFACE MODE: RGB: 16/18 BIT MCU: 8/16/18 BIT PARALLEL DATA SPI DATA (3)MODULE SIZE: $50.5W*69.45H*4.15(D) \text{ mm} \rightarrow 50.5W*69.6H*4.45(D) \text{ mm}$ (4) ACTIVE AREA: 43.38W * 57.64H mm(T/P) \rightarrow 44.2W * 58.6H mm(T/P) 2 3.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS PARAMETER POWER SUPPLY FOR DIGITAL SYMBOL MIN. MAX. UNIT IOVCC -0.3 3.3 V PARAMETER POWER SUPPLY FOR DIGITAL 3 ADD 4.2 AC CHARACTERISTICS 9,10 5. OPTICAL CHARACTERISTICS ONTRAST RA RESPONSE TIME THE BRIGHTNESS 350 cd/m F MODULI COLOR OF CIE COORDINATE GREEN BLUE VIEWING ANGLE RESPONSE TIME THE BRIGHTNESS 280 NTSC: 60% VIEWING ORMAL AUNL $\theta x = 0^{\circ}$ $\theta y = 0^{\circ}$ OF MODULE COLOR OF RED COORDINATE GREEN BLUE ADD NOTE $(2)\sim(7)$ ADD 5.2 THE TEST METHOD OF BRIGHTNESS AND UNIFORMITY ADD 5.3 THE CALCULATING METHOD OF UNIFORMITY 12 7. BLOCK DIMENSIONS MODIFY IC GATE NO 14, 15 9. INTERFACE SIGNAL UPDATE PIN 17~PIN 34 FUNCTION 10. POWER SUPPLY 16 VDD 2.3~3.3V 2.3~3.3V IOVCC VDD 1.65 ~3.3V T1.65 ~3.3V GND VLED(A) VLED(A ₼ IF=80mA VLED(K1) VF(3.3V) VLED(K2) VLED(K3) VLED(K) VLED(K4) LCD MODULE LCD MODULE DELETE 12.3 DEFINITION OF OPTICAL CHARACTERISTICS DELETE 12.4 OUTLINE OF OPTICAL MEASURING SYSTEM 30 12.4.1 STANDARD SPECIFICATIONS FOR RELIABILITY OF LCD MODULE NO. 4: $40^{\circ}\text{C} \rightarrow 50^{\circ}\text{C}$, NO. 5: $40^{\circ}\text{C} \rightarrow 60^{\circ}\text{C}$

MODEL NO. VERSION **PAGE** EMERGING DISPLAY TECHNOLOGIES CORPORATION ET028002DHU 5 0-2DOC . FIRST ISSUE NOV.13, 2007 RECORDS OF REVISION REVISED DATE **PAGE** SUMMARY NO. JAN.29, 2008 3.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS NOTE (4): Ta \leq 60°C: 90%HR (96HRS MAX.) \rightarrow $Ta \le 60^{\circ}C: 90\%RH (96HRS MAX.)$ 9,10 5.1 OPTICAL CHARACTERISTICS LED BACKLIGHT ED BACKLIGHT SYMBOL CONDITION LED BACKLIGHT LED LIFE TIME ADD NOTE (8) 5.2 THE TEST METHOD OF BRIGHTNESS AND UNIFORMITY 1/6X 1/3X 1/3X ·Ó 🖒 🕉 -🛈 🖒 Ġ **⊕** 80mA -456 -4 5 6 F VF(3.3) □ > \$ -0 8 9 -0 8 9 12 7. BLOCK DIMENSIONS NO.39 : $XR \rightarrow XL$, NO.41 : $XL \rightarrow XR$ 15 9. INTERFACE SIGNALS NO.39 : $XR \rightarrow XL$, RIGHT PANEL \rightarrow LEFT PANEL NO.41 : $XL \rightarrow XR$, LEFT PANEL \rightarrow RIGHT PANEL 23 12. **SPECIFICATION** OF AUDACITY **ASSURANCE→INSPECTION CRITERION** REVISING THE ENTIRE PAGE 12.2.4 INSPECTION METHOD MINOR DEFECT : AQL $2.5 \rightarrow AQL 1.0$ 24 12.3.1VISUAL DEFECTS CLASSIFICATION MINOR DEFECT : DELETE 3.PCB, AQL : $2.5 \rightarrow 1.0$ 32 ADD 12.5.5 NOT ALLOWED TO INFLICT ANY EXTERNAL STRESS AND TO CAUSE ANY MECHANICAL INTERFERENCE ON THE BENDING AREA OF FPC DURING THE TAIL BENDING BACKWARDS! DO NOT STRESS FPC AND IC ON THE MODULE! JUL.17, 2008 9 5.1 OPTICAL CHARACTERISTICS NOTE (2) : $2^{\circ} \rightarrow 1^{\circ}$ 11 6. OUTLINE DIMENSIONS MARK △: ADD TEXT, DELETE CN2 23 12.2.4 INSPECTION METHOD (b)AQL : Major defect : AQL $0.65\% \rightarrow AQL \ 0.65$ Minor defect : AQL $1.0\% \rightarrow AQL 1.0$ FEB.23, 2009 6. OUTLINE DIMENSIONS 11 MARK 🕸 : ADD NOTE

MODEL NO. VERSION PAGE
E T 0 2 8 0 0 2 D H U 5 0-3

TABLE OF CONTENTS

NO.	I T E M	PAGE
=====		
1.	GENERAL SPECIFICATIONS	1
2.	MECHANICAL SPECIFICATIONS	1
3.	ABSOLUTE MAXIMUM RATINGS	2
4.	ELECTRICAL CHARACTERISTICS	3 ~ 8
5.	OPTICAL CHARACTERISTICS	9,10
6.	OUTLINE DIMENSIONS	11
7.	BLOCK DIMENSIONS	12
8.	DETAIL DRAWING OF DOT MATRIX	13
9.	INTERFACE SIGNALS	14, 15
10.	POWER SUPPLY	16
11.	TOUCH PANEL SPECIFICATION	17 ~ 22
12.	INSPECTION CRITERION	23 ~ 32

MODEL NO. VERSION PAGE EMERGING DISPLAY TECHNOLOGIES CORPORATION ET028002DHU 5 1

1. GENERAL SPECIFICATIONS

1.1 APPLICATION NOTES FOR CONTROLLER/DRIVER PLEASE REFER TO:

HIMAX HX8347-A

1.2 MATERIAL SAFETY DESCRIPTION ASSEMBLIES SHALL COMPLY WITH EUROPEAN ROHS REQUIREMENTS, INCLUDING PROHIBITED MATERIALS/COMPONENTS CONTAINING LEAD, MERCURY, CADMIUM, HEXAVALENT CHROMIUM, POLYBROMINATED BIPHENYLS (PBB) AND POLYBROMINATED DIPHENYL ETHERS (PBDE)

2. MECHANICAL SPECIFICATIONS

(1) DIAGONALS	2.8 inch
(2) NUMBER OF DOTS	240W * (RGB) * 320H DOTS
(3) MODULE SIZE	50.5W * 69.6H * 4.45(D) mm
	(WITHOUT FPC SIZE)
(4) ACTIVE AREA	43.2W * 57.6H mm (LCD)
	44.2W * 58.6H mm(T/P)
(5) PIXEL SIZE	0.18W * 0.18H mm
(6) LCD TYPE	TFT, TRANSMISSIVE
(7) COLOR	262K (18BIT)
(8) VIEWING DIRECTION	12 O'CLOCK
(9) BACK LIGHT	LED, COLOR: WHITE
(10) INTERFACE MODE	RGB: 16/18 BIT

MCU: 8/16/18 BIT PARALLEL DATA SPI DATA

MODEL NO.	VERSION	PAGE
ET028002DHU	5	2

3. ABSOLUTE MAXIMUM RATINGS

3.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	MIN.	MAX.	UNIT	REMARK
POWER SUPPLY FOR DIGITAL	IOVCC	-0.3	4.6	V	
POWER SUPPLY FOR ANALOG	VCI	-0.3	4.6	V	
INPUT VOLTAGE	V _{IN}	-0.3	V _{CI} +0.3	V	

3.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS.

ITEM	OPERATING		STOF	RAGE	REMARK	
I I E WI	MIN.	MIN. MAX. MIN. MAX.		KLWAKK		
AMBIENT TEMPERATURE	-20°C	70°C	-30°C	80°C	NOTE (2), (3)	
HUMIDITY		_	_	_	WITHOUT CONDENSATION NOTE (4)	
VIBRATION		2.45m/S ² (0.25G)		11.76m/S ² (1.2 G)	5~20Hz , 1HR 20~500Hz(20Hz), 1HR 20~500Hz(500Hz), 1HR X, Y, Z, TOTAL 3HR	
SHOCK		29.4 m/S ² (3G)	_	490m/S ² (50 G)	10 m SECONDS XYZ DIRECTIONS 1 TIME EACH	
CORROSIVE GAS	NOT ACC	EPTABLE	NOT ACC	EPTABLE		

NOTE (2) : Ta AT -30°C : 48HR MAX .

80°C:168HR MAX.

NOTE (3): BACKGROUND COLOR CHANGES SLIGHTLY DEPENDING ON AMBIENT

TEMPERATURE THIS PHENOMENON IS REVERSIBLE.

NOTE (4) : $Ta \le 60^{\circ}C : 90\%RH (96HRS MAX.)$

Ta > 60°C: ABSOLUTE HUMIDITY MUST BE LOWER THAN THE HUMIDITY OF

90%RH AT 60°C.(96 HRS MAX.)

MODEL NO.	VERSION	PAGE
E T 0 2 8 0 0 2 D H U	5	3

4. ELECTRICAL CHARACTERISTICS

4.1 DC CHARACTERISTICS

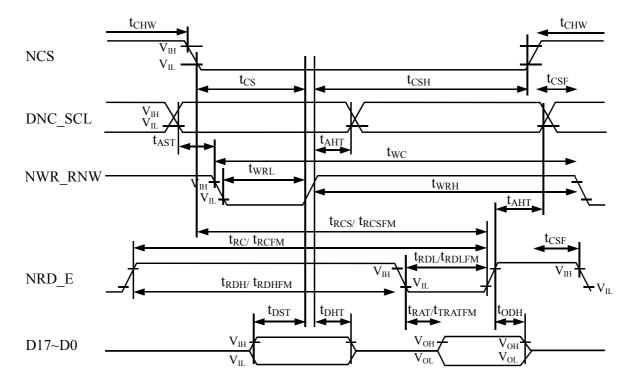
 $Ta = 25 \, ^{\circ}C$

							1 u 25 C
PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
INPUT POWER SUPPLY	V_{CI}	OPERATION VOLTAGE	2.3	2.8	3.3	V	
INTERFACE OPERATION VOLTAGE	IOVCC	I/O SUPPLY VOLTAGE	1.65	2.8	3.3	V	
INPUT CURRENT	I_{DD}	_	_	5	10	mA	
INPUT VOLTAGE	V_{IH}	H LEVEL	0.8* I _{OVCC}		I _{ovcc}	V	
NOTE (1)	$V_{\rm IL}$	L LEVEL	-0.3	_	0.2* I _{OVCC}	V	
OUTPUT VOLTAGE	V_{OH}	H LEVEL	0.8* I _{OVCC}			V	
NOTE (1)	V_{OL}	L LEVEL	_		0.8* I _{OVCC}	V	

NOTE (1): APPLIED TO TERMINALS /RESET, /RS,/WR,/RD,/CS, D17, D16......D0.

4.2 AC CHARACTERISTICS

4.2.1 PARALLEL INTERFACE CHARACTERISTICS (8080-SERIES MPU)



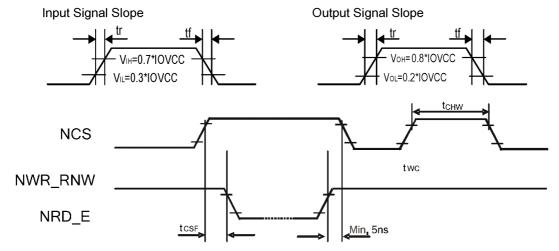
NCS

MODEL NO.	VERSION	PAGE
E T 0 2 8 0 0 2 D H U	5	4

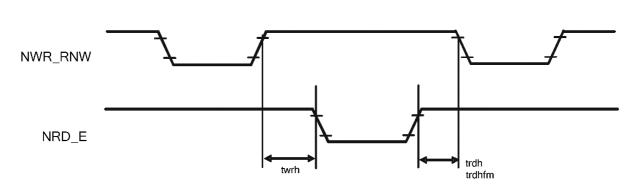
(VSSA=0V, IOVCC=1.65V to 2.50V, VCI=2.3V to 2.9V, Ta = -30 to 70°C)

SIGNAL	SYMBOL	PARAMETER	MIN.	MAX.	UNIT	DESCRIPTION
DNC SCL	t_{AST}	ADDRESS SETUP TIME	10		ns	
	$t_{ m AHT}$	ADDRESS HOLD TIME (WRITE/READ)	10			
	t_{CHW}	CHIP SELECT "H" PULSE WIDTH	0			
	t_{CS}	CHIP SELECT SETUP TIME (WRITE) CHIP SELECT SETUP TIME	35			
NCS	t_{RCSFM}	CHIP SELECT WAIT TIME	355	_	ns	
	t_{CSF}	(WRITE/READ)	10			
	t_{CSH}	CHIP SELECT HOLD TIME	10			
	$t_{ m WC}$	WRITE CYCLE	100	_		
NWR_RNW	$t_{ m WRH}$	CONTROL PULSE "H" DURATION	35		ns	
	t_{WRL}	CONTROL PULSE "L" DURATION	35	_		
	t_{RCFM}	READ CYCLE	450			WHEN READ
NRD_E	$t_{ m RDHFM}$	CONTROL PULSE "H" DURATION	90		ns	FROM GRAM
_	t_{RDLFM}	CONTROL PULSE "L" DURATION	355			FROM GRAM
	$t_{ m DST}$	DATA SETUP TIME	15			FOR MAXIMUM
D17 TO D0	$t_{ m DHT}$	DATA HOLD TIME	10	_	ns	CL=30pF
0171000	t_{RATFM}	READ ACCESS TIME		340	115	FOR MINIMUM
	t_{ODH}	OUTPUT DISABLE TIME	20	80		CL=8pF

NOTE: THE INPUT SIGNAL RISE TIME AND FALL TIME (TR, TF) IS SPECIFIED AT 15 NS OR LESS. LOGIC HIGH AND LOW LEVELS ARE SPECIFIED AS 30% AND 70% OF IOVCC FOR INPUT SIGNALS.

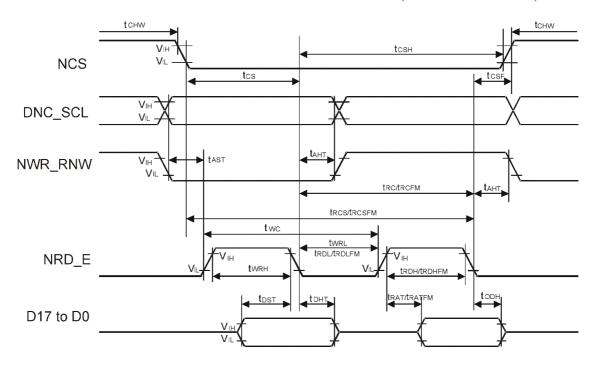


NOTE: LOGIC HIGHT AND LOW LEVELS ARE SPECIFIED AS 30% AND 70% OF IOVCC



NOTE: LOGIC HIGH AND LOW LEVELS ARE SPECIFIED AS 30% AND 70% OF IOVCC

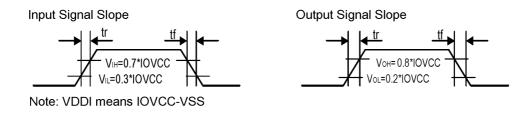
4.2.2 PARALLEL INTERFACE CHARACTERISTICS (6800-SERIES MPU)



(VSSA=0V, IOVCC=1.65V to 2.50V, VCI=2.3V to 2.9V, Ta = -30 to 70°C)

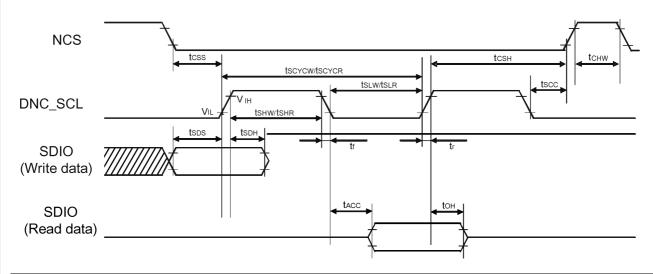
		(VBSA 0V, 10 VCC 1.03 V to 2				
SIGNAL	SYMBOL	PARAMETER	MIN.	MAX.	UNIT	DESCRIPTION
DMG GGI	$t_{ m AST}$	ADDRESS SETUP TIME	10			
DNC_SCL	t_{AHT}	ADDRESS HOLD TIME (WRITE/READ)	10		ns	
	t_{CHW}	CHIP SELECT "H" PULSE WIDTH	0			
	t_{CS}	CHIP SELECT SETUP TIME (WRITE)	35			
NCS	t_{RCSFM}	CHIP SELECT SETUP TIME	355		ns	
	t_{CSF}	CHIP SELECT WAIT TIME (WRITE/READ)	10			
	t_{CSH}	CHIP SELECT HOLD TIME	10			
	$t_{ m WC}$	WRITE CYCLE	100			
NWR_RNW	$t_{ m WRH}$	CONTROL PULSE "H" DURATION	35		ns	
_	$t_{ m WRL}$	CONTROL PULSE "L" DURATION	35			
	$t_{ m RCFM}$	READ CYCLE	450			WHEN DE AD
NRD_E	$t_{ m RDHFM}$	CONTROL PULSE "H" DURATION	90		ns	WHEN READ
_	$t_{ m RDLFM}$	CONTROL PULSE "L" DURATION	355			FROM GRAM
	T_{dst}	DATA SETUP TIME	10			EOD MAVIMUM
D17 TO D0	$t_{ m DHT}$	DATA HOLD TIME	10			FOR MAXIMUM
	t_{RAT}	READ ACCESS TIME (ID)		40	ns	CL=30pF FOR MINIMUM
	t_{RATFM}	READ ACCESS TIME (FM)		340		
	t_{ODH}	OUTPUT DISABLE TIME	20	80		CL=8pF

NOTE: THE INPUT SIGNAL RISE TIME AND FALL TIME (TR, TF) IS SPECIFIED AT 15 NS OR LESS. LOGIC HIGH AND LOW LEVELS ARE SPECIFIED AS 30% AND 70% OF IOVCC FOR INPUT SIGNALS.



MODEL NO.	VERSION	PAGE
ET028002DHU	5	6

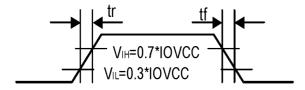
4.2.3 SERIAL INTERFACE CHRARCTERISTICS



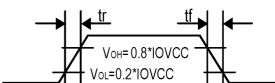
PARAMETER	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
SERIAL CLOCK CYCLE (WRITE)	t_{SCYCW}		100		_	
DNC_SCL "H" PULSE WIDTH (WRITE)	$t_{ m SHW}$	DNC_SCL	35			ns
DNC_SCL "L" PULSE WIDTH (WRITE)	$t_{ m SLW}$		35		—	
DATA SETUP TIME (WRITE)	t_{SDS}	SDI	30			ns
DATA HOLD TIME (WRITE)	t_{SDH}	SDI	30			113
SERIAL CLOCK CYCLE (READ)	t_{SCYCR}		150			
DNC_SCL "H" PULSE WIDTH (READ)	t_{SHR}	DNC_SCL	60			ns
DNC_SCL "L" PULSE WIDTH (READ)	$t_{\rm SLR}$		60			
ACCESS TIME	t_{ACC}	SDO FOR MAXIMUM CL=30pF FOR MINIMUM CL=8pF	45	_	100	ns
OUTPUT DISABLE TIME	t_{OH}	SDO FOR MAXIMUM CL=30pF FOR MINIMUM CL=8pF	15		100	ns
DNC_SCL TO CHIP SELECT	t_{SCC}	DNC_SCL, NCS	15		—	ns
NCS "H" PULSE WIDTH	$t_{\rm CHW}$	NCS	45			ns
CHIP SELECT SETUP TIME	t_{CSS}	NCS	60			ns
CHIP SELECT HOLD TIME	t_{CSH}	1100	65			113

NOTE: THE INPUT SIGNAL RISE TIME AND FALL TIME (TR, TF) IS SPECIFIED AT 15 NS OR LESS. LOGIC HIGH AND LOW LEVELS ARE SPECIFIED AS 30% AND 70% OF IOVCC FOR INPUT SIGNALS.

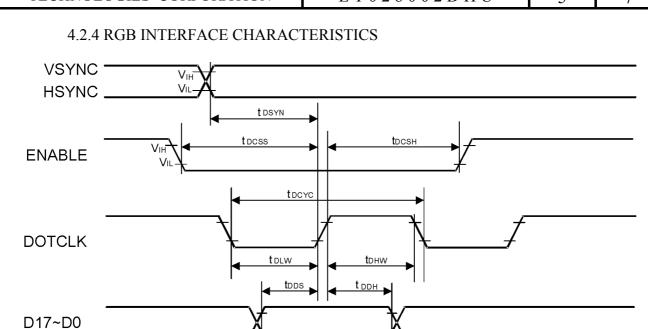
Input Signal Slope



Output Signal Slope



MODEL NO.	VERSION	PAGE
ET028002DHU	5	7

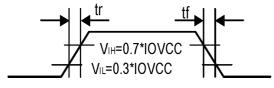


SYMBOL	PARAMETER	CONDITIONS	RELATED PINS	MIN.	TYP.	MAX.	UNIT
t_{DCYC}	DOTCLK CYCLE TIME	VRR = Min. 50 Hz Max. 65 Hz	DOTCLK	60 (NOTE2)		226 (NOTE3)	ns
$t_{ m DLW} \ t_{ m CHW}$	DOTCLK LOW TIME DOTCLK HIGH TIME			15 15		<u> </u>	ns
$t_{ m DDS}$ $t_{ m DDH}$	RGB DATA SETUP TIME RGB DATA HOLD TIME		DOTCLK, D17-D0	15 15			ns
$t_{ m DCSS}$ $t_{ m DCSH}$	ENABLE SETUP TIME ENABLE HOLD TIME		ENABLE	15 15			ns
$t_{ m DSYN}$	SYNC SETUP TIME		DOTCLK, HSYNC, VSYNC	15			ns

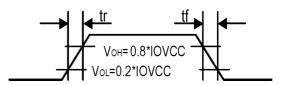
NOTE: (1) THE INPUT SIGNAL RISE TIME AND FALL TIME (tr, tf) IS SPECIFIED AT 15 NS OR LESS.

- (2) 16.6MHz
- (3) 4.4MHz



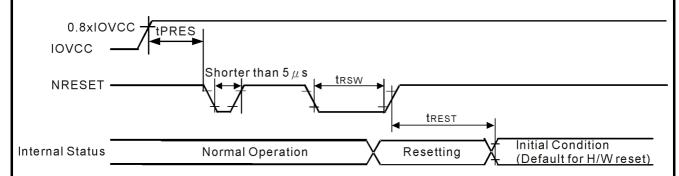


Output Signal Slope



MODEL NO.	VERSION	PAGE
ET028002DHU	5	8

4.2.5 RESET INPUT TIMING



SYMBOL	PARAMETER	RELATED PINS	MIN.	TYP.	MAX.	NOTE	UNIT
t_{RESW}	RESET LOW PULSE WIDTH ⁽¹⁾	NRESET	10				μs
4	RESET COMPLETE TIME ⁽²⁾	_	_	_	1 5	WHEN RESET APPLIED DURING STB MODE	ms
$t_{ m REST}$	RESET COMPLETE TIME	_			1 120	WHEN RESET APPLIED DURING STB MODE	ms
t	RESET GOES HIGH LEVEL AFTER POWER ON TIME	NRESET & IOVCC	1			RESET GOES HIGH LEVEL AFTER POWER ON	ms

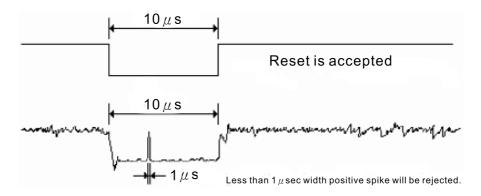
NOTE: (1) SPIKE DUE TO AN ELECTROSTATIC DISCHARGE ON NRESET LINE DOES NOT CAUSE IRREGULAR SYSTEM RESET ACCORDING TO THE TABLE BELOW.

NRESET PULSE	ACTION
SHORTER THAN 5µs	RESET REJECTED
LONGER THAN 10µs	RESET
BETWEEN 5μs AND 10μs	RESET START

NOTE: (2) DURING THE RESETTING PERIOD, THE DISPLAY WILL BE BLANKED (THE DISPLAY IS ENTERING BLANKING SEQUENCE, WHICH MAXIMUM TIME IS 120 MS, WHEN RESET

STARTS

- IN STB OUT –MODE. THE DISPLAY REMAINS THE BLANK STATE IN STB –MODE) AND THEN RETURN TO DEFAULT CONDITION FOR H/W RESET.
- (3) DURING RESET COMPLETE TIME, ID2 AND VCOMOF VALUE IN OTP WILL BE LATCHED TO INTERNAL REGISTER DURING THIS PERIOD. THIS LOADING IS DONE EVERY TIME WHEN THERE IS H/W RESET COMPLETE TIME (TREST) WITHIN 5MS AFTER A RISING EDGE OF NRESET.
- (4) SPIKE REJECTION ALSO APPLIES DURING A VALID RESET PULSE AS SHOWN BELOW:



(5) IT IS NECESSARY TO WAIT 5MSEC AFTER RELEASING! RES BEFORE SENDING COMMANDS. ALSO STB OUT COMMAND CANNOT BE SENT FOR 120MSEC.

MODEL NO.	VERSION	PAGE
E T 0 2 8 0 0 2 D H U	5	9

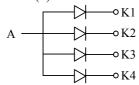
5. OPTICAL CHARACTERISTICS NOTE (2)

5.1 OPTICAL CHARACTERISTICS

 $Ta = 2.5 \, ^{\circ}C$

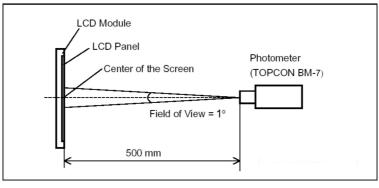
ITEM		SYMBOL	COND	ITION	MIN.	TYP.	MAX.	UNIT	REMARK		
1 1 2		θ_{X} +	23112		70	75	_	21,11			
VIEWING	HOR.	θх-	CENTER	θy=0°	65	70		1	(2)		
ANGLE	MED	θу+	CR≥10	0 00	70	75		deg .	(3)		
	VER.	θу-	1	$\theta x=0^{\circ}$	50	55					
CONTRAST RAT	IO	CR			400	500			(4)		
RESPONSE TIME	,	tr(rise)				10	20	mg	(5)		
KESFONSE IIWIE	b .	tf(fall)				15	30	ms	(5)		
THE BRIGHTNESS OF MODULE		В	NTSC: 60%		240	280	_	cd/m²	(6)		
	WHITE	Wx	VIEWING NORMAL AUNLE		0.260	0.310	0.360				
	WIIIIE	Wy			0.291	0.341	0.391				
COLOR OF	RED	Rx			$\theta x = 0^{\circ}$		0.605	0.655	0.705		
CIE	KED	Ry	$\theta y = 0^{\circ}$		0.279	0.329	0.379		(7)		
COORDINATE	GREEN	Gx			0.262	0.312	0.362		(7)		
COORDINATE	GREEN	Gy			0.525	0.575	0.625				
	BLUE	Bx			0.084	0.134	0.184				
	DLUL	By			0.085	0.135	0.185				
THE BRIGHTNESS OF UNIFORMITY			_		75	80	_	%	_		
CURRENT FOR LED BACKLIGHT		A-K	$I_F = 80 \text{mA}$		_	3.3	_	V	NOTE (1)		
LED LIFE TIME		_	_	_	30000	40000	_	hrs			

NOTE (1):



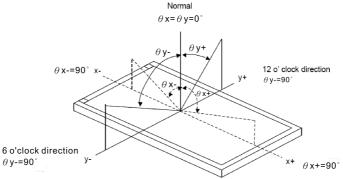
NOTE (2): TEST EQUIPMENT SETUP:

AFTER STABILIZING AND LEAVING THE PANEL ALONE AT A GIVEN TEMPERATURE FOR 30 MINUTES, THE MEASUREMENT SHOULD BE EXECUTED. MEASUREMENT SHOULD BE EXECUTED IN A STABLE, WINDLESS, AND DARK ROOM. OPTICAL SPECIFICATIONS ARE MEASURED BY TOPCON BM-7 (FAST) WITH A VIEWING ANGLE OF 1° AT A DISTANCE OF 50cm AND NORMAL DIRECTION.



MODEL NO.	VERSION	PAGE
ET028002DHU	5	10

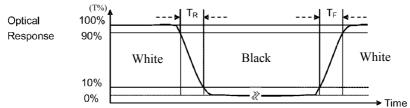
NOTE (3): DEFINITION OF VIEWING ANGLE:



NOTE (4): DEFINITION OF CONTRAST RATIO:

 $CONTRASTRATIO(CR) = \frac{BRIGHTNESS\ MEASURED\ WHEN\ LCD\ IS\ AT\ "WHITE\ STATE"}{BRIGHTNESS\ MEASURED\ WHEN\ LCD\ IS\ AT\ "BLACK\ STATE"}$

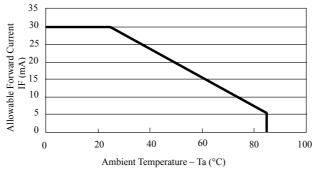
NOTE (5): DEFINITION OF RESPONSE TIME: TR AND TF
THE FIGURE BYELOW IS THE OUTPUT SIGNAL OF THE PHOTO DETECTOR.



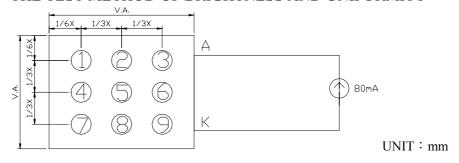
NOTE (6): BRIGHTNESS MEASURED WHEN LCD IS AT "WHITE STATE"

NOTE (7): THE 100% TRANSMISSION IS DEFINED AS THE TRANSMISSION OF LCD PANEL WHEN ALL THE INPUT TERMINALS OF MODULE ARE ELECTRICALLY OPENED.

NOTE (8): AMBIENT TEMP. VS. ALLOWABLE FORWARD CURRENT



5.2 THE TEST METHOD OF BRIGHTNESS AND UNIFORMITY

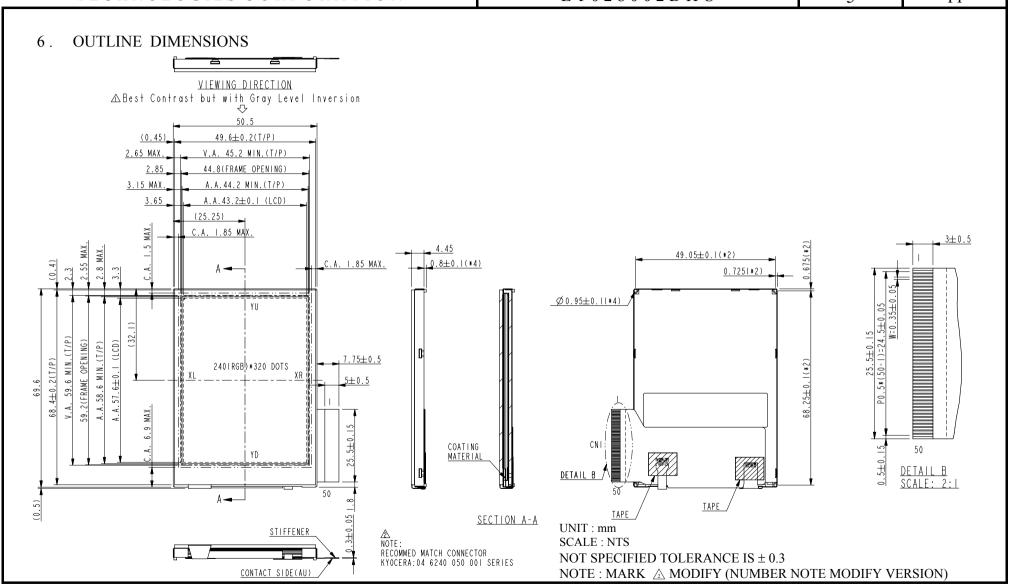


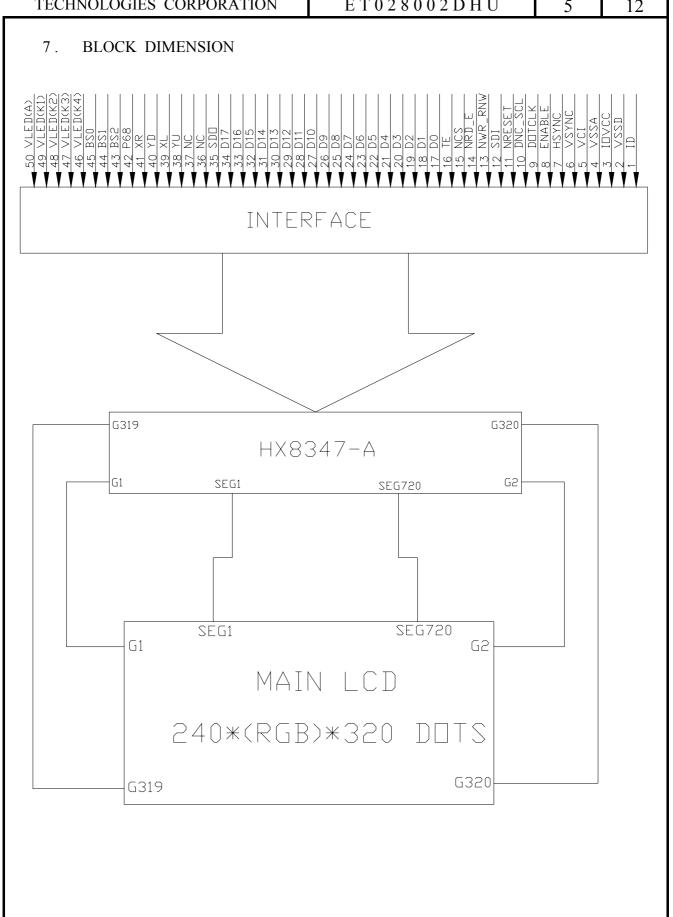
5.3 THE CALCULATING METHOD OF UNIFORMITY



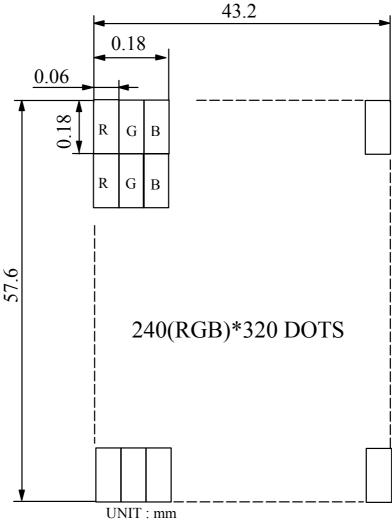
E M E R G I N G D I S P L A Y TECHNOLOGIES CORPORATION

MODEL NO.	VERSION	PAGE
ET028002DHU	5	11









SCALE : NTS

NOT SPECIFIED TOLERANCE IS \pm 0.1 DOTS MATRIX TOLERANCE IS \pm 0.01

MODEL NO.	VERSION	PAGE
ET028002DHU	5	14

9. INTERFACE SIGNALS

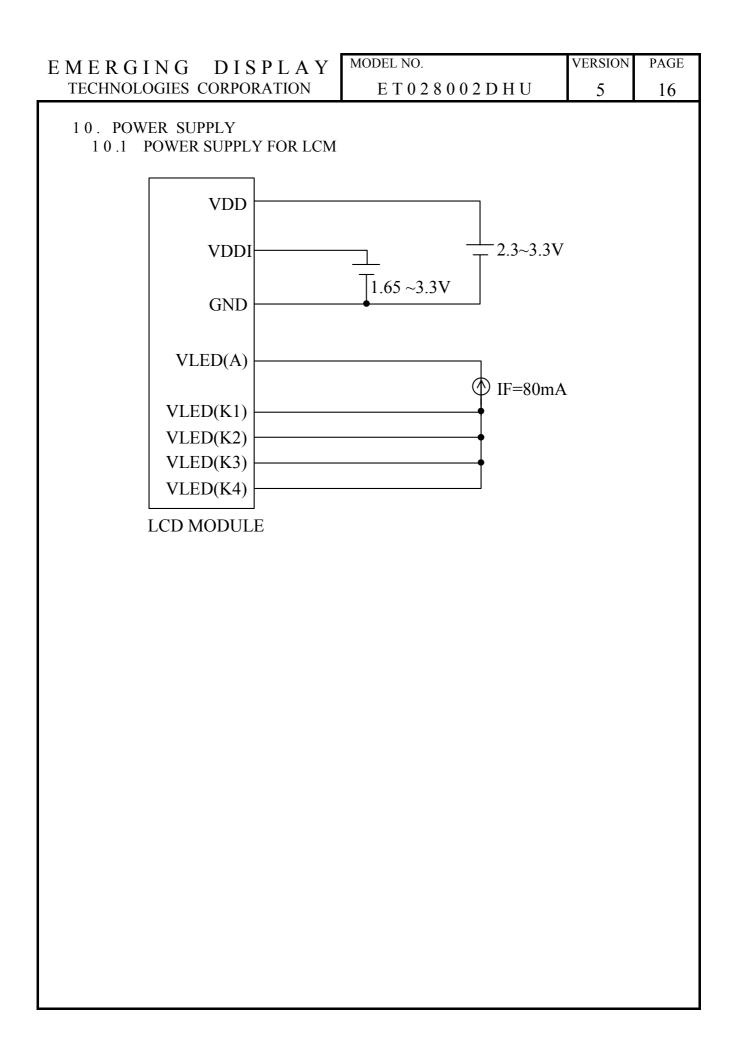
9.1 LCD MODULE CONNECTOR

9.1 LCD MODULE CONNECTOR						
PIN NO	SYMBOL	REMARK	FUNCTION			
1	ID	0	MAKER'S IDENTIFICATION (MAY ESTABLISH "H", "L" OR "NC") IF THE CUSTOMER HAS MORE THAN TWO MAKERS WHO APPLIED DIFFERENT S/W, CAN USE THIS PIN TO DETECT THE CODE BY THE MPU AND DECIDE THE MAKER'S ID. MOST IMPORTANTLY, THE CUSTOMER MUST DESIGN THIS PIN ON THE MAIN BOARD AS WELL AND LEAVE IT OPEN AS NOT USED. NOTE: EDT MODULE'S SETTING IS"H".			
2	VSSD	I	DIGITAL GROUND			
3	IOVCC	I	DIGITAL IO PAD POWER SUPPLY			
4	VSSA	I	ANALOG GROUND			
5	VCI	I	ANALOG POWER SUPPLY			
6	VSYNC	Ι	FRAME SYNCHRONIZING SIGNAL. HAS TO BE FIXED TO IOVCC LEVEL IF IS NOT USED.			
7	HSYNC	Ι	FRAME SYNCHRONIZING SIGNAL. HAS TO BE FIXED TO IOVCC LEVEL IF IS NOT USED.			
8	ENABLE	I	A DATA ENABLE SIGNAL IN RGB I/F MODE. HAS TO BE FIXED TO VSSD LEVEL IF UNUSED (HIGH ACTIVE, IF EPL=0).			
9	DOTCLK	Ι	DOT CLOCK SIGNAL. HAS TO BE FIXED TO VSSD LEVEL IF IS NOT USED.			
10	DNC_SCL	I	THE SIGNAL FOR COMMAND OR PARAMETER SELECT UNDER PARALLEL MODE (I.E.NOT SERIAL INTERFACE): LOW: COMMAND. HIGH: PARAMETER. WHEN UNDER SERIAL INTERFACE, IT SERVERS AS SCL.			
11	NRESET	I	RESET PIN. SETTING EITHER PIN LOW INITIALIZES THE LSI. MUST BE RESET AFTER POWER IS SUPPLIED.			
12	SDI	I	SERIAL DATA PIN. WHEN IFSEL0=0, IT IS SERIAL DATA INPUT/OUTPUT PIN (SDA). WHEN IFSEL0=1, IT IS SERIAL DATA INPUT PIN. IF NOT USED, PLEASE LET IT CONNECTED TO IOVCC OR VSSD.			
13	NWR_RNW	I	I80 SYSTEM: SERVES AS A WRITE SIGNAL AND WRITES DATA AT THE RISING EDGE. M68 SYSTEM: 0: WRITE, 1: READ. FIX IT TO IOVCC OR VSSD LEVEL WHEN USING SERIAL BUSS INTERFACE.			
14	NRD_E	I	I80 SYSTEM: SERVES AS A READ SIGNAL AND READ DATA AT THE LOW LEVEL. M68 SYSTEM: 0: READ/WRITE DISABLE, 1: READ/WRITE ENABLE. FIX IT TO IOVCC OR VSSD LEVEL WHEN USING SERIAL BUSS INTERFACE.			
15	NCS	I	CHIP SELECT SIGNAL. LOW: CHIP CAN BE ACCESSED; HIGH: CHIP CANNOT BE ACCESSED. MUST BE CONNECTED TO VSSD IF NOT IN USE.			
16	TE	О	TEARING EFFECT OUTPUT, IF NOT USED, PLEASE OPEN THIS PIN.			

 MODEL NO.
 VERSION
 PAGE

 ET028002DHU
 5
 15

						<u></u>		
DINI NO	CVADOL	DEMARK		—	—	FUNCTION		
PIN NO		REMARK				FUNCTION		-
17	D0	I/O	_					
18	D1	I/O	_					
19	D2	I/O						
20	D3	I/O	1. 18-BIT	BI-I	DIRF	ECTIONAL DATA BUS FOR	SYSTEM INTERFACE.	
21	D4	I/O	8-BIT B	sUS:	: USI	E D7-D0 AND D17-D8 UNUS	SED.	
22	D5	I/O				SE D15-D0 AND D17-D16 UN	NUSED.	
23	D6	I/O				SE D17-D0		
24	D7	I/O				BUS FOR RGB INTERFACE		
25	D8	I/O	_			SE D15-D0 AND D17-D16 UN	NUSED.	
26	D9	I/O				SE D17-D0	r exter	
27	D10	I/O				NUSED PINS TO THE VSSD I REGISTER RGB EN=1 AND		
28	D11	I/O				AS STREAM IMAGE DATA I		
29	D12	I/O	IT MEAN				FOR DISI LAT.	
30	D13	I/O				OATA BUS IS SHARED.		
31	D14	I/O		-				
32	D15	I/O						
33	D16	I/O]					
34	D17	I/O						
35	SDO	О	+			UTPUT. IF NOT USE, LET IT	TO OPEN.	
36	NC	NC	NO USE, I					
37	NC	NC	NO USE, I		<u>`IT (</u>	<u>OPEN</u>		
38	YU	0	TOP PAN					
39	XL	0	LEFT PAN					
40	YD	0	DOWN PA					
41	XR	О	RIGHT PA					
'						16-BIT BUS INTERFACE, 80-SYSTEM,	D17-D16 : UNUSED,	
42	P68	I	0 0	0	0	65K-COLOR	D15-D0: DATA	
'			0 0	0 0 0 1 262K-COLOR		D17-D16: UNUSED, D15-D0: DATA		
!	<u> </u>	<u> </u>	0 0	1	0	18-BIT BUS INTERFACE, 80-SYSTEM, 262K-COLOR	D17-D0: DATA	
			0 0	1	1	8-BIT BUS INTERFACE, 80-SYSTEM,	D17-D8: UNUSED	
43	BS2	I	0 1	0	0	262K-COLOR 16-BIT BUS INTERFACE, 80-SYSTEM,	D7-D0: DATA D17-D8: UNUSED	1
	===	-				262K-COLOR	D7-D0: DATA	Ì
'	<u> </u>	<u> </u>	0 1	0	1	18-BIT BUS INTERFACE, 80-SYSTEM, 262K-COLOR	D17-D0: DATA	
			1 0	0	0	16-BIT BUS INTERFACE, 68-SYSTEM, 65K-COLOR	D17-D16: UNUSED, D15-D0: DATA	1
44	BS1	I	1 0	0	1	16-BIT BUS INTERFACE, 68-SYSTEM, 262K-COLOR	D17-D16: UNUSED, D15-D0: DATA	
' '			1 0	1	0	18-BIT BUS INTERFACE, 68-SYSTEM,	D17-D0: DATA	1
'			<u> </u>			262K-COLOR 8-BIT BUS INTERFACE, 68-SYSTEM,	D17-D8:UNUSED	
			1 0	1	1	262K-COLOR 16-BIT BUS INTERFACE, 68-SYSTEM.	D7-D0: DATA D17-D8: UNUSED	
45	BS0	I	1 1	0	0	262K-COLOR	D7-D8: UNUSED D7-D0: DATA	
7.0	Doo	1	1 1	0	1	18-BIT BUS INTERFACE, 68-SYSTEM, 262K-COLOR	D17-D0: DATA	
	'		× 1	1	0	SERIAL BUS IF	DNC_SCL, SDO,SDI	
46	VLED(K4)	I	POWER S	UPI	PLY	FOR LED(-)		
47	VLED(K3)	I	POWER S	UPI	PLY	FOR LED(-)		
48	VLED(K2)	I				FOR LED(-)		
49	VLED(K1)	I				FOR LED(-)		
50	VLED(A)	I	POWER S	UPI	PLY	FOR LED(+)		



MODEL NO.	VERSION	PAGE
ET028002DHU	5	17

11. TOUCH PANEL SPECIFICATION

11.1 ELECTRICAL CHARACTERISTICS

 $Ta = 25^{\circ}C$

ITEM	CONDITION	SPEC.	UNIT
LINEARITY	_	≤ 1.5	%
TRANSMISSION	ASTM D1003	Min 80	%
TERMINAL RESISTANCE	X AXIS	160 ~ 640	0
TERMINAL RESISTANCE	Y AXIS	260 ~ 1040	22
INSULATION RESISTANCE	DC25V	≥ 20	$M\Omega$

11.2 ABSOLUTE MAXIMUM RATINGS :

ITEM	MIN.	TYP.	MAX.
OPERATING TEMPERATURE (Top)	-30°C		70°C
STORAGE TEMPERATURE (Tst)	-40°C		+80°C
INPUT VOLTAGE (V)		5	

11.3 PRECAUTIONS IN USE OF TOUCH PANEL

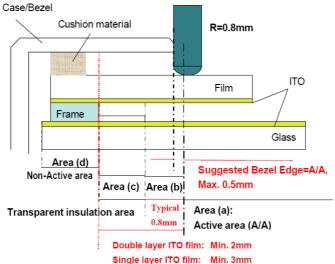
11.3.1 PURPOSE:

IN ORDER TO PREVENT ACCIDENTAL USE AND PERFORMANCE DETERIORATION, PLEASE KEEP THE FOLLOWING PRECAUTIONS AND INHIBITED POINTS.

11.3.2 ITEM AND ILLUSTRATION:

(1) STRUCTURE, AREA DEFINITION

THE STRUCTURE AND THE PERFORMANCE GUARANTEED AREA OF THIS TOUCH PANEL ARE DEFINED BELOW:



THE ABOVE FIGURE IS OUR DESIGN RULE OF TOUCH PANEL. IF IT CANNOT MEET YOUR REQUIREMENT, PLEASE CONTACT WITH OUR ENGINEERS FOR FURTHER DISCUSSION.

ABOVE FIGURE ILLUSTRATES THE RECOMMENDED BEZEL AND CUSHION DESIGN. IN ORDER TO PREVENT

UNUSUAL PERFORMANCE DEGRADATION AND MALFUNCTION OF A TOUCH PANEL, PLEASE CARRY OUT THE SET

CASE DESIGNING AND A TOUCH PANEL ASSEMBLING METHOD AFTER SURELY CONSIDERING THE DEFINITION OF EACH AREA ILLUSTRATED IN ABOVE FIGURE.

MODEL NO.	VERSION	PAGE
ET028002DHU	5	18

AREA(a) : ACTIVE AREA

THE ACTIVE AREA IS GUARANTEED THE POSITION DATA DETECTABLE PRECISION, OPERATION FORCE AND OTHER OPERATIONS. IT IS STRONGLY RECOMMENDED TO PLACE THE OPERATION BUTTON OR MENU KEYS WITHIN THE ACTIVE AREA. DUE TO STRUCTURE, THE ACTIVE AREA IS LESS DURABLE AT THE EDGE OR CLOSE TO THE EDGE.

AREA(b): OPERATION NON-GUARANTEED AREA

THIS AREA DOES NOT GUARANTEE A TOUCH PANEL OPERATION AND ITS FUNCTION. WHEN THIS AREA IS PRESSED, TOUCH PANEL SHOWS DEGRADATION OF ITS PERFORMANCE AND DURABILITY SUCH AS A PEN SLIDING DURABILITY BECOMES ABOUT ONE-TENTH COMPARED WITH THE ACTIVE AREA (AREA-(A) AS GUARANTEED AREA) AND ITS OPERATION FORCE REQUIRES ABOUT DOUBLE. ABOUT 0.5 MM OUTSIDE FROM A BOUNDARY OF THE ACTIVE AREA CORRESPONDS TO THIS AREA.

AREA(c): PRESSING PROHIBITION AREA

THE AREA WHICH FORBIDS PRESSING, BECAUSE AN EXCESSIVE LOAD IS APPLIED TO A TRANSPARENT ELECTRODE (ITO) AND A SERIOUS DAMAGE IS GIVEN TO A TOUCH PANEL FUNCTION BY PRESSING.

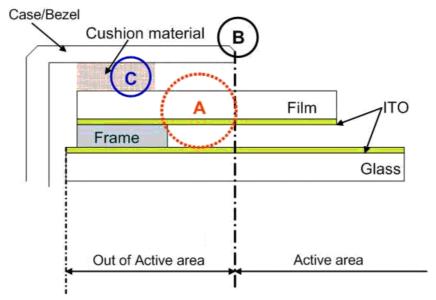
AREA(d): NON-ACTIVE AREA

THE AREA DOES NOT ACTIVATE EVEN IF PRESSED.

- (2) CAUTIONS FOR INSTALLING AND ASSEMBLING
 - (i) DO NOT GIVE EXCESSIVE STRAIN TO THE PRODUCT.
 - (ii) FLEXIBLE PATTERN CABLE IS CONNECTED TO THE BODY BY THERMAL PRESSURE METHOD. SO, DO NOT APPLY EXCESSIVE FORCES TO THE FLEXIBLE PATTERN. DO NOT ADD AN EXCESSIVE FORCE TO A FPC (FLEX TAIL) THAT MAKES PEELING OFF OF THE FPC FROM THE PRODUCT. DO NOT FIX, ADHERE OR MOUNT ANY ADDITIONAL GOODS ON THE FPC SUCH AS ADDITIONAL FILM/PLATE ON THE FPC, BECAUSE SUCH ADDITIONAL GOODS WILL APPLY A STRESS AT THE FPC BONDING AREA. IT MAY AFFECT THE CONDUCTIVITY OF FPC WITH TOUCH PANEL.
 - (iii) IN ORDER NOT TO APPLY LOAD ON THE DISPLAY, PROVIDE A CLEARANCE OF AT LEAST 0.3MM BETWEEN THE PRODUCT AND DISPLAY.
 - (iv) WE RECOMMEND THE DESIGN OF A CASE OR BEZEL SHOULD COVERS THE BOUNDARY OF THE ACTIVE AREA INSIDE IN ORDER TO PREVENT AN OPERATION AT OUTSIDE OF THE ACTIVE AREA WHICH CAN NOT GUARANTEE THE FUNCTION OR DURABILITY.

 BEZEL'S EDGE PART MAY GUIDE THE PEN SLIDING ON THE SAME POSITION REPEATEDLY. IF THE BEZEL IS PLACED OUTSIDE OF THE ACTIVE AREA, IT MAY CAUSE THE DAMAGE OF THE ITO FILM.

(v) PRESSING INSIDE OF BOUNDARY OF THE FRAME(PART (A) AS SHOWN IN BELOW) MAY CAUSES FAULT OPERATION, SO PLEASE DESIGN TO AVOID PRESSING OF TOUCH PANEL AT PART (A) SUCH AS HAVING GASKET/CUSHION AT PART (C). PARTICULARLY THE AREA (B) SHALL BE FREE FROM BURR. THE GASKET/CUSHION MATERIAL AT THE PART (C) SHOULD NOT BE EXCEEDED TO INSIDE OF THE BOUNDARY OF THE FRAME.



- (vi) TO PREVENT GIVING DISTORTION TO THE FILM OF THE PRODUCT AND PEELING OFF OF THE FILM FROM THE PRODUCT, DO NOT FIX THE FILM AND A SET CASE OR A SHOCK ABSORBING MATERIAL ADHERED TO A SET CASE BY ADHESION.
- (vii) WIPE OFF THE STAIN ON THE PRODUCT BY USING SOFT CLOTH MOISTENED WITH ETHANOL. TAKE CARE NOT TO ALLOW ETHANOL TO SOAK INTO THE JOINT OF UPPER FILM AND BOTTOM GLASS. IT MAY OTHERWISE CAUSE PEELING OR DEFECTIVE OPERATION. DO NOT USE ANY ORGANIC SOLVENT OR DETERGENT OTHER THAN ETHANOL.
- (viii) THE CORNERS OF THE PRODUCT ARE NOT CHAMFERED AND ARE SHARP. WHEN POSITIONING AND FIXING THE PRODUCT ON THE CASE, PROVIDE A ROUND PART ON THE CORNER OF THE CASE SO AS NOT TO APPLY LOAD ON THE CORNER OF THE TRANSPARENT TOUCH PANEL.
 - (ix) DO NOT PRESS THE FILM OF THE PRODUCT WHEN THIS PRODUCT IS BUILT INTO A SET.
- (3) CAUTIONS FOR OPERATION
 - (i) OPERATE IT WITH A POLYACETAL PEN (TIP R0.8 OR OVER) OR A BELLY OF A FINGER WITHOUT APPLYING EXCESSIVE LOAD. NEVER USE ANY MECHANICAL PENCILS, BALL POINT PENS AND HARD FINGERTIPS WHO'S TIP IS HARD FOR INPUT, OTHERWISE MALFUNCTIONS MAY RESULT.

MODEL NO.	VERSION	PAGE
ET028002DHU	5	20

- (ii) THE INPUT POSITION MAY BE FLUCTUATED A LITTLE THROUGH LONG-TIME USE. IT IS DESIRABLE TO PROVIDE A ZERO-ADJUSTMENT FUNCTION BY USING A CIRCUIT AND SOFTWARE.
- (iii) OPERATION AT THE OUT OF ACTIVE AREA IS OUT OF OUR GUARANTEE. IT CAUSES A SERIOUS DAMAGE OF A TRANSPARENT ELECTRODE. DO NOT OPERATE AT THE OUT OF ACTIVE AREA.
- (iv) IN CASE OF CLEANING THE PART OF THE CASE BOUNDARY OF ACCOMPLISHED SET, USE A SOFT CLOTH WITH A FINGER BERRY OR A COTTON BUD. DO NOT CLEAN WITH A THI NG OTHER THAN THE FINGER SUCH AS HARD OR SHARP EDGES LIKE A FINGER NAIL ETC. ON THE CLOTH, BECAUSE IT CAUSE TRANSPARENT CONDUCTIVE FILM CRACKS. PLEASE ADVISE THIS PROHIBITION TO YOUR LAST CUSTOMERS.

11.4 DURABILITY

11.4.1 STYLUS HITTING:

ONE MILLION TIMES OR OVER NO DAMAGE ON FILM SURFACE PEN: R8 mm SILICON RUBBER

LOAD: 250g

FREQUENCY: 120 times/min MEASUREMENT POSITION:

1 POINT OF TOUCH PANEL ACTIVE AREA

REPEATED: OVER 1,000,000 TIMES

11.4.2 PEN TOUCH SLIDING DURABILITY:

100,000 TIMES OR OVER

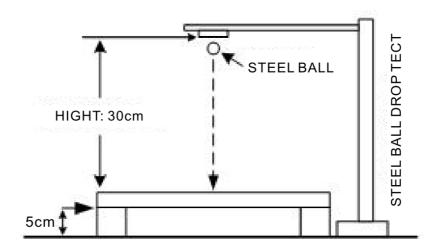
WRITING WITH R0.8mm PLASTIC STYLUS PEN; WRITING FORCE 150g IN ACTIVE AREA.

SPEED IS 70mm/sec.

MODEL NO.	VERSION	PAGE
ET028002DHU	5	21

11.5 STEEL BALL DROP TEST

BY USING Ø9mm STEEL BALL FROM THE HEIGHT OF 30cm AND FALLING ON TOUCH PANEL SURFACE, MUST PASS BELOW CONDITIONS: APPEARANCE: THE APPEARANCE WITHOUT ANY CHANGE, INCLUDING THE PANEL BROKEN.



11.6 APPEARANCE INSPECTION

PURPOSE:

TO ESTABLISH APPEARANCE STANDARD AND MAINTAIN PRODUCT QUALITY \circ

SCOPE:

TOUCH PANEL VIEW AREA WITHIN TOUCH PANEL •

11.6.1 RULE:

INSPECTION CONDITION

- (A) ENVIRONMENTAL LUMINANCE: 500 LUX •
- (B) DISTANCE BETWEEN HUMAN EYES AND PANEL: 30 CM (PANEL MUST BE TESTED UNDER LIGHT TRANSPARENT) •
- (C) VISUAL ANGEL: $> 60^{\circ}$
- (D) LIGHT SOURCE: FLUORESCENT LIGHT SOURCE •

11.6.2 JUDGE CRITERION:

JUDGEMENT UNDER ABOVE MENTIONED CRITERION (PANEL MUST BE TESTED UNDER LIGHT TRANSPARENT), TESTING GOODS DEFECT CAN BE VISIBLE WITHIN 10 SECONDS, WHICH WILL BE JUDGED AS MAJOR DEFECTS •

11.6.3 SAMPLING STANDARD:

THE SAMPLING STANDARD WILL BE CONFIRMED BY BOTH OF EDT AND CUSTOMER.

MODEL NO. VERSION PAGE ET028002DHU 5 22

INSPECTION ITEMS		SEPC.	JUDGE CRITERION	OPERATION GUIDELINE	
COD A TOLL	W ≤ 0.05mm & L≤5mm		ACCEPTABLE	REFL	
SCRATCH	W > 0.05	mm or L > 5mm	NOT ACCEPTABLE	BACK GROUND TESTING GOODS	
LINEAR FOREIGN	W ≤ 0.05mm & L ≤5mm		ACCEPTABLE	FLUORESCENT LIGHT SOURCE	
OBJECT	W > 0.05	mm or L >5mm	NOT ACCEPTABLE	300mm =	
	D:	≤ 0.15mm	ACCEPTABLE	ENVIRONMENTAL IUMINANCE : 500Lux REFL	
GRANULAR	0.15mm < D ≤0.2mm		MAX. 2 EA	FLUORESCENT LIGHT SOURCE TESTING GOODS 300mm	
FOREIGN OBJECT	0.2mm	ı < D ≤0.3mm	MAX. 1 EA	ENVIRONMENTAL IUMINANCE : 500Lux W Line	
	D >0.3mm		NOT ACCEPTABLE	L	
PET BUBBLES	D ≤0.5mm		ACCEPTABLE	D	
TET BOBBLES	D >0.5mm		NOT ACCEPTABLE	D	
CHIP ON GLASS	CORNER	$X \le 3 \text{mm}$ $Y \le 3 \text{mm}$ $Z < t$ (t = thickness)	ACCEPTABLE	Chip of glass	
3-1-3-2-2	EDGE	$W \le 2mm \cdot Y \le 3mm \cdot Z < t$		Z X X	
FLAW	<i>-</i>		NOT ACCEPTABLE	Flaw on glass	

MODEL NO.	VERSION	PAGE
ET028002DHU	5	23

12. INSPECTION CRITERION

12.1 APPLICATION

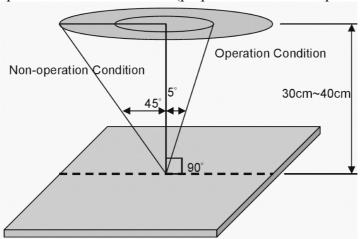
This inspection standard is to be applied to the LCD module delivered from EMERGING DISPLAY TECHNOLOGIES CORP.(E.D.T) to customers

12.2 INSPECTION CONDITIONS

12.2.1 (1)Observation Distance: 35cm±5cm

(2) View Angle:

Non-operation Condition : ±5°(perpendicular to LCD panel surface) Operation Condition : ±45° (perpendicular to LCD panel surface)



12.2.2 Environment Conditions:

Amb	ient Temperature	20°C~25°C
Ambient Humidity		65±20%RH
Ambient	Cosmetic Inspection	More than 600Lux
Illumination	Functional Inspection	300~500 Lux

12.2.3 Inspection lot

Quantity per delivery lot for each model

12.2.4 Inspection method

A sampling inspection shall be made according to the following provisions to judge The acceptability

(a) Applicable standard: MIL-STD-105E

Normal inspection, single sampling

Level II

(b)AQL : Major defect : AQL 0.65 Minor defect : AQL 1.0

EMERGING DISPLAY MODEL 19 TECHNOLOGIES CORPORATION ET

MODEL NO.	VERSION	PAGE
ET028002DHU	5	24

12.3 INSPECTION STANDARDS

12.3.1 VISUAL DEFECTS CLASSIFICATION

TYPE OF DEFECT	INSPECTION ITEM	DEFECT FEATURE	AQL
	1.DISPLAY ON	DEFECT TO MISS SPECIFIED DISPLAY FUNCTION, FOR ALL AND SPECIFIED DOTS EX: DISCONNECTION, SHORT CIRCUIT ETC	0.64
MAJOR DEFECT	2.BACKLIGHT	NO LIGHT FLICKERING AND OTHER ABNORMAL ILLUMINATION	0.65
	3.DIMENSIONS	• SUBJECT TO INDIVIDUAL ACCEPTANCE SPECIFICATIONS	
	1.DISPLAY ZONE	 BLACK/WHITE SPOT BUBBLES ON POLARIZER BLACK/WHITE LINE SCRATCH CONTAMINATION LEVER COLOR SPREED 	
MINOR DEFECT	2.BEZEL ZONE	STAINSSCRATCHESFOREIGN MATTER	1.0
	3.SOLDERING	 INSUFFICIENT SOLDER SOLDERED IN INCORRECT POSITION CONVEX SOLDERING SPOT SOLDER BALLS SOLDER SCRAPS 	
	4.DISPLAY ON (ALL ON)	• LIGHT LINE	

MODEL NO.	VERSION	PAGE
ET028002DHU	5	25

12.3.2 MODULE DEFECTS CALSSIFICATION

NO.	12.3.2 MODULE ITEM	DEFECTS CAL		TERIA	
1.	DISPLAY ON INSPECTION	(1)INCORRECT PATTERN (2)MISSING SEGMENT (3)DIM SEGMENT (4)OPERATING VOLTAGE BEYOND SPEC			
2.	OVERALL DIMENSIONS	(1)OVERALL DIMENSION BEYOND S			
3.	DOT DEFECT	BRIGHT DOT DARK DOT TOAL BRIGHT NOTE: 1. THE DEFINITION THE SIZE OF A REGARDED AS 2. BRIGHT DOT: DOTS APPEAR PANEL IS DISPONS 3. DARK DOT: DOTS APPEAR	ITEMS BRIGHT DOT DARK DOT TOAL BRIGHT AND DARK DOTS NOTE: 1. THE DEFINITION OF DOT: THE SIZE OF A DEFECTIVE DOT ON REGARDED AS ONE DEFECTIVE DOTO. BRIGHT DOT: DOTS APPEAR BRIGHT AND UNCH PANEL IS DISPLAYING UNDER BLACE. DOTS APPEAR DARK AND UNCHAIN PANEL IS DISPLAYING UNDER PUBLIC DOTS APPEAR DARK AND UNCHAIN PANEL IS DISPLAYING UNDER PUBLIC DOTS APPEAR DARK AND UNCHAIN PANEL IS DISPLAYING UNDER PUBLIC DOTS APPEAR DARK AND UNCHAIN PANEL IS DISPLAYING UNDER PUBLIC DOTS APPEAR DARK AND UNCHAIN PANEL IS DISPLAYING UNDER PUBLIC DOTS APPEAR DARK AND UNCHAIN PANEL IS DISPLAYING UNDER PUBLIC DOTS APPEAR DARK AND UNCHAIN PANEL IS DISPLAYING UNDER PUBLIC DOTS APPEAR DARK AND UNCHAIN PANEL IS DISPLAYING UNDER PUBLIC DOTS APPEAR DARK AND UNCHAIN PANEL IS DISPLAYING UNDER PUBLIC DARK PUBLIC PUBLIC DARK PUBLIC DARK PUBLIC PUBLIC PUBLIC PUBLIC PUBLIC PUBLIC PUBLIC PUBLIC		E DOT IS WHICH LCD
4.	FOREIGN BLACK/WHITE/ BRIGHT LINE/ SCRATCH OF VIEWING AREA	LENGTH: L $L \le 0.3$ $0.3 < L \le 2.5$ $2.5 < L$	WIDTH: W $W \le 0.05$ $0.05 < W \le 0.1$ $0.1 < W$	PERMISSIBLE NO. IGNORE 4 NONE	
5.	FOREIGN MATTER \ BLACK SPOTS \ WHITE SPOTS \ DENT (INCLUDING LIGHT LEAKAGE DUE TO POLARIZING PLATES PINHOLES, ETC.)	WIDTH: W mm, LENGH: L mm AVERAGE DIAMETER (mm): D $D \le 0.1$ $0.1 < D \le 0.4$ $0.4 < D$ NOTE: DIAMETER D=(a+b)/2		NUMBER OF PIECES PERMITTED IGNORE 4 NONE	

 MODEL NO .
 VERSION
 PAGE

 ET028002DHU
 5
 26

NO.	ITEM	CRITERIA			
			AVERAGE DIAMETER (mm): D	NUMBER OF PIECES PERMITTED	
		DUDDI E ON THE	D ≤ 0.25	IGNORE	
		BUBBLE ON THE POLARIZER	$0.25 < D \le 0.5$	N ≤ 5	
		I OE/IRIZER	0.5 < D	NOTE	
		SURFACE STATUS	D < 0.1 mm	IGNORE	
			$0.1 < D \le 0.3$ mm	N ≤ 3	
		CF FAIL / SPOT	D < 0.1 mm	IGNORE	
			$0.1 < D \le 0.3$ mm	N ≤ 3	
6.	BUBBLES OF POLARIZER /DIRT/CF FAIL /SURFACE STAINS	ON ACTIV BUBBLE S APPEARS (2)THE EXT OBSERVI (3)THE DEF AS FOLL	VE DISPLAY AREA. THE I SHALL BE IGNORED IF T ON THE OUTSIDE OF AC RANEOUS SUBSTANCE I ED WHEN THE MODULE INITION OF AVERAGE D	HE POLARIZER BUBBLE CTIVE DISPLAY AREA. S DEFINED AS IT CAN BE	
7.	LINE DEFECT ON DISPLAY	OBVIOUS VERTICAL OR HORIZONTAL LINE DEFECT IS NOT ALLOW			
8.	MURA ON DISPLAY	IT'S OK IF MURA IS SLIGHT VISIBLE THROUNG 6% ND FILTER			
9.	UNEVEN COLOR SPREAD, COLORATION	(1)TO BE DETERMINED BASED UPON THE STANDARD SAMPLE.			
10.	BEZEL APPEARANCE	(1)BEZEL MAY NOT HAVE RUST, BE DEFORMED OR HAVE FINGER PRINTS STAINS OF OTHER CONTAMINATION. (2)BEZEL MUST COMPLY WITH JOB SPECIFICATIONS.			
11	РСВ	THE SEAL AREA (THAN THREE PLA (2)NO OXIDATION O (3)PARTS ON PCB MI CHARACTERISTIC THERE SHOULD B PARTS. (4)THE JUMPER ON T CHARACTERISTIC (5)IF SOLDER GETS (OR CONTAMINATION PCE UST BE THE SAME AS ON CCHART. SE NO WRONG PARTS, MI	E SHOULD BE NO MORE B TERMINALS N THE PRODUCTION ISSING PARTS OR EXCES ORM TO THE PRODUCT ED PAD, ZEBRA PAD OR	

EMERGING DISPLAY

TECHNOLOGIES CORPORATION

 MODEL NO.
 VERSION
 PAGE

 ET028002DHU
 5
 27

(1)NO SOLDERING FOUND ON THE SPECIFIED PLACE (2)INSUFFICENT SOLDER (a)LSI, IC A POOR WETTING OF SOLDER IS BETWEEN LOWER BEND OR "HEEL" OF LEAD AND PAD SOLDER FILLET (b)CHIP COMPONENT SOLDER IS LESS THAN 50% OF SIDES AND FRONT FACE WETTING SOLDER FILLET 1/2 SOLDER FILLET 1/2 SOLDER FILLET 1/2 SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED SOLDER SOLDER SOLDER SOLDER SOLDER SOLDER SOLDER
(a)LSI, IC A POOR WETTING OF SOLDER IS BETWEEN LOWER BEND OR "HEEL" OF LEAD AND PAD SOLDER FILLET • SOLDER IS LESS THAN 50% OF SIDES AND FRONT FACE WETTING SOLDER FILLET 1/2 • SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF SIDES AND FRONT SURFACE AREA ARE COVERED
(3)PARTS ALIGMENT (a)LSI, IC LEAD WIDTH IS MORE THAN 50% BEYOND PAD OUTLINE

 MODEL NO .
 VERSION
 PAGE

 ET028002DHU
 5
 28

NO.	ITEM	CRITERIA
		(b)CHIP COMPONENT COMPONENT IS OFF CENTER, AND MORE THAN 50% OF THE LEADS IS OFF THE PAD OUTLINE
12.	SOLDERING	
		(4)NO UNMELTED SOLDER PASTE MAY BE PRESENT ON THE PCB. (5)NO COLD SOLDER JOINTS, MISSING SOLDER CONNECTIONS, OXIDATION OR ICICLE. (6)NO RESIDUE OR SOLDER BALLS ON PCB. (7)NO SHORT CIRCUITS IN COMPONENTS ON PCB.
13.	BACKLIGHT	(1)NO LIGHT (2)FLICKERING AND OTHER ABNORMAL ILLUMINATION (3)SPOTS OR SCRATCHES THAT APPEAR WHEN LIT MUST BE JUDGED USING LCD SPOT, LINES AND CONTAMINATION STANDARDS. (4)BACKLIGHT DOESN'T LIGHT OR COLOR IS WRONG.
14.	GENERAL APPEARANCE	(1)NO OXIDATION, CONTAMINATION, CURVES OR, BENDS ON INTERFACE PIN (OLB) OF TCP. (2)NO CRACKS ON INTERFACE PIN (OLB) OF TCP. (3)NO CONTAMINATION, SOLDER RESIDUE OR SOLDER BALLS ON PRODUCT. (4)THE IC ON THE TCP MAY NOT BE DAMAGED, CIRCUITS. (5)THE UPPERMOST EDGE OF THE PROTECTIVE STRIP ON THE INTERFACE PIN MUST BE PRESENT OR LOOK AS IF IT CAUSE THE INTERFACE PIN TO SEVER. (6)THE RESIDUAL ROSIN OR TIN OIL OF SOLDERING (COMPONENT OR CHIP COMPONENT) IS NOT BURNED INTO BROWN OR BLACK COLOR. (7)SEALANT ON TOP OF THE ITO CIRCUIT HAS NOT HARDENED. (8)PIN TYPE MUST MATCH TYPE IN SPECIFICATION SHEET. (9)LCD PIN LOOSE OR MISSING PINS. (10)PRODUCT PACKAGING MUST THE SAME AS SPECIFIED ON PACKAGING SPECIFICATION SHEET. (11)PRODUCT DIMENSION AND STRUCTURE MUST CONFORM TO PRODUCT SPECIFICATION SHEET. (12)THE APPEARANCE OF HEAT SEAL SHOULD NOT ADMIT ANY DIRT AND BREAK.

 MODEL NO.
 VERSION
 PAGE

 ET028002DHU
 5
 29

NO.	ITEM	CRITERIA			
		THE LCD WITH EXTENSIVE OF GENERAL GLASS CHIP:	$ \begin{array}{c c} a \\ & \leq t/2 \\ \hline & t/2 > , \leq 2t \\ \hline *W=DISTANCI \end{array} $	b < VIEWING AREA ≤ W/2 E BETWEEN AREA AND LOOGE E LENGTH	c ≤ 1/8X ≤ 1/8X
15. CI	RACKED GLASS	CORNER PART: CHIP ON ELECTRODE PAD a	PANEL ED $X = LCD SIDI$ $t = GLASS TI$ a $\leq t$ $* X=LCD SIDE$	AREA AND LODGE E LENGTH HICKNESS b ≤ 0.5mm WIDTH	c ≤ 1/8X ≤ 1/8X CD
		c a	*X=LCD SIDE t = GLASS THE L=ELECTROE TERMINAL, REMAIN AN ACCORDING TERMINAL ©IF THE PROE SEALED BY THE ALIGNN	=GLASS THICKNESS	

MODEL NO.	VERSION	PAGE
ET028002DHU	5	30

12.4 RELIABILITY TEST

12.4.1 STANDARD SPECIFICATIONS FOR RELIABILITY OF LCD MODULE

NO	ITEM	DESCRIPTION
1		THE SAMPLE SHOULD BE ALLOWED TO STAND AT +70°C FOR 240 HRS
2		THE SAMPLE SHOULD BE ALLOWED TO STAND AT -20°C FOR 240 HRS
3		THE SAMPLE SHOULD BE ALLOWED TO STAND AT +80°C FOR 240 HRS
4		THE SAMPLE SHOULD BE ALLOWED TO STAND AT -30°C FOR 240 HRS
5		THE SAMPLE SHOULD BE ALLOWED TO STAND AT 50°C, 90% RH 240 HRS
6	HIGH TEMPERATURE / HIGH HUMIDITY STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT 60°C, 90% RH 240 HRS
7	THERMAL SHOCK (NOT OPERATED)	THE SAMPLE SHOULD BE ALLOWED TO STAND THE FOLLOWING 10 CYCLES OF OPERATION: -30°C FOR 30 MINUTES +80°C FOR 30 MINUTES
8	ESD (ELECTROSTATIC DISCHARGE)	AIR DISCHARGE ± 4KV CONTACT DISCHARGE ± 2KV
9		6 FACES, 2 CORNERS HEIGHT : 750mm

MODEL NO.	VERSION	PAGE
E T 0 2 8 0 0 2 D H U	5	31

12.4.2 TESTING CONDITIONS AND INSPECTION CRITERIA

FOR THE FINAL TEST THE TESTING SAMPLE MUST BE STORED AT ROOM TEMPERATURE FOR 24 HOURS, AFTER THE TESTS LISTED IN TABLE 6.2, STANDARD SPECIFICATIONS FOR RELIABILITY HAVE BEEN EXECUTED IN ORDER TO ENSURE STABILITY.

NO	ITEM	TEST MODEL	INSPECTION CRITERIA
1	CURRENT CONSUMPTION	REFER TO SPECIFICATION	THE CURRENT CONSUMPTION SHOULD CONFORM TO THE PRODUCT SPECIFICATION.
2	CONTRAST	REFER TO SPECIFICATION	AFTER THE TESTS HAVE BEEN EXECUTED, THE CONTRAST MUST BE LARGER THAN HALF OF ITS INITIAL VALUE PRIOR TO THE TESTS.
3	APPEARANCE	VISUAL INSPECTION	DEFECT FREE

12.4.3 LIFE TIME

	FUNCTIONS, PERFORMANCE, APPEARANCE, ETC.
LIFE TIME	SHALL BE FREE FROM REMARKABLE DETERIORATION
	WITHIN 50,000 HOURS UNDER ORDINARY OPERATING
	AND STORAGE CONDITIONS ROOM TEMPERATURE
LIFE HIVIE	(25±10°c), NORMAL HUMIDITY (45±20% RH), AND IN
	AREA NOT EXPOSED TO DIRECT SUN LIGHT.
	(LIFE TIME OF BACKLIGHT, PLEASE REFER TO DATA
	ABOUT BACKLIGHT.)

NOTE: FROM OUR EXPERIENCE THE LIFE TIME OF HIGH HUMIDITY OPERATION AND HIGH TEMPERATURE OPERATION AS ABOVE MENTIONED COULD BE ACHIEVED.

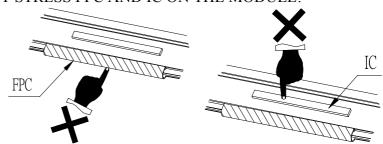
12.5 OPERATION

- 12.5.1 DO NOT CONNECT OR DISCONNECT MODULES TO OR FROM THE MAIN SYSTEM WHILE POWER IS BEING SUPPLIED .
- 12.5.2 USE THE MODULE WITHIN SPECIFIED TEMPERATURE; LOWER TEMPERATURE CAUSES THE RETARDATION OF BLINKING SPEED OF THE DISPLAY; HIGHER TEMPERATURE MAKES OVERALL DISPLAY DISCOLOR. WHEN THE TEMPERATURE RETURNS TO NORMALITY, THE DISPLAY WILL OPERATE NORMALLY.
- 12.5.3 ADJUST THE LC DRIVING VOLTAGE TO OBTAIN THE OPTIMUM CONTRAST .
- 12.5.4 POWER ON SEQUENCE INPUT SIGNALS SHOULD NOT BE SUPPLIED TO LCD MODULE BEFORE POWER SUPPLY VOLTAGE IS APPLIED AND REACHES THE SPECIFIED VALUE (5 ±0.25V). IF ABOVE SEQUENCE IS NOT FOLLOWED, CMOS LSIS OF LCD MODULES MAY BE DAMAGED DUE TO LATCH UP PROBLEM.

MODEL NO.	VERSION	PAGE
ET028002DHU	5	32

12.5.5 NOT ALLOWED TO INFLICT ANY EXTERNAL STRESS AND TO CAUSE ANY MECHANICAL INTERFERENCE ON THE BENDING AREA OF FPC DURING THE TAIL BENDING BACKWARDS!

DO NOT STRESS FPC AND IC ON THE MODULE!



12.6 NOTICE

- 12.6.1 USE A GROUNDED SOLDERING IRON WHEN SOLDERING CONNECTOR I/O TERMINALS . FOR SOLDERING OR REPAIRING, TAKE PRECAUTION AGAINST THE TEMPERATURE OF THE SOLDERING IRON AND THE SOLDERING TIME TO PREVENT PEELING OFF THE THROUGH-HOLE-PAD .
- 12.6.2 DO NOT DISASSEMBLE . EDT SHALL NOT BE HELD RESPONSIBLE IF THE MODULE IS DISASSEMBLED AND UPON THE REASSEMBLY THE MODULE FAILED .
- 12.6.3 DO NOT CHARGE STATIC ELECTRICITY, AS THE CIRCUIT OF THIS MODULE CONTAINS CMOS LSIS. A WORKMAN'S BODY SHOULD ALWAYS BE STATIC-PROTECTED BY USE OF AN ESD STRAP. WORKING CLOTHES FOR SUCH PERSONNEL SHOULD BE OF STATIC-PROTECTED MATERIAL.
- 12.6.4 ALWAYS GROUND THE ELECTRICALLY-POWERED DRIVER BEFORE USING IT TO INSTALL THE LCD MODULE. WHILE CLEANING THE WORK STATION BY VACUUM CLEANER, DO NOT BRING THE SUCKING MOUTH NEAR THE MODULE; STATIC ELECTRICITY OF THE ELECTRICALLY-POWERED DRIVER OR THE VACUUM CLEANER MAY DESTROY THE MODULE.
- 12.6.5 DON'T GIVE EXTERNAL SHOCK.
- 12.6.6 DON'T APPLY EXCESSIVE FORCE ON THE SURFACE.
- 12.6.7 LIQUID IN LCD IS HAZARDOUS SUBSTANCE. MUST NOT LICK AND SWALLOW.
 WHEN THE LIQUID IS ATTACHED TO YOUR, SKIN, CLOTHE ETC.WASH IT OUT THOROUGHLY AND IMMEDIATELY.
- 12.6.8 DON'T OPERATE IT ABOVE THE ABSOLUTE MAXIMUM RATING.
- 12.6.9 STORAGE IN A CLEAN ENVIRONMENT, FREE FROM DUST, ACTIVE GAS, AND SOLVENT.
- 12.6.10 STORE WITHOUT ANY PHYSICAL LOAD.
- 12.6.11 REWIRING: NO MORE THAN 3 TIMES.